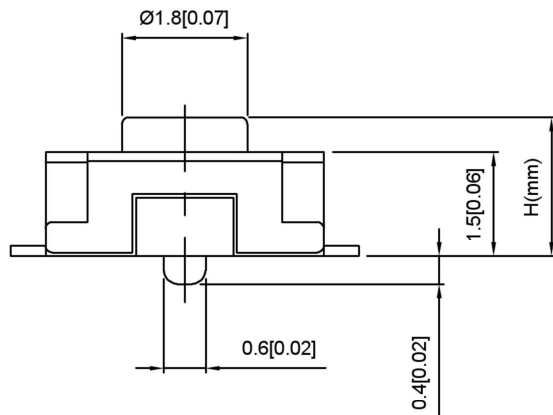
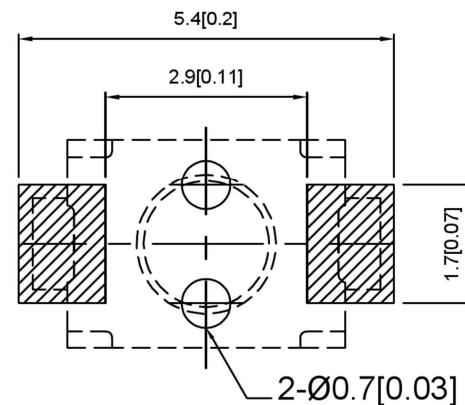
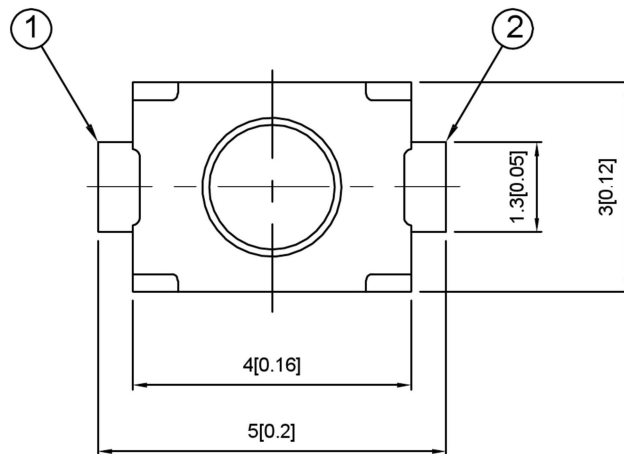


SPECIFICATION

Contact Rating:	50mA, 12V DC
Contact Resistance:	100mΩ max
Insulation Resistance:	100mΩ min. 500V DC
Dielectric Strength:	250V AC/1minute
Travel:	0.13mm
Operating Temp:	-30℃~+85℃
Storage Temp:	-30℃~+80℃

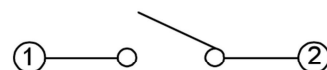
PCB MOUNTING PATTERN DIMENSION

The following soldering patterns are recommended for reflow soldering



PAPT NO	TS-1185-X-X-X-A
Operating Force	A:100gf B:160gf C:260gf
Height	H:A:2.0 B:2.5
Fixed column	A:With B:Without
Keystake	A:PA46 B:Silica gel

CIRCUIT DIAGRAM



⑤	Terminal	—	2	Brass (0.30t)	Plating silvering	—
④	Contact	—	1	F.ag/Sus	Natural	—
③	Base	—	1	LCP		—
②	Cover	—	1	Brass	Plating Nickel	—
①	Keystake	—	1	LCP		—
ITEM	PAPT NAMF	TER,NO	QTY	MATERIAL	FINISHING	REMARK

				ANGLAR	±5°
				L ≤ 4	±0.2
				4 < L ≤ 16	±0.3
				16 < L ≤ 63	±0.4
	DATE	REVISED	APPROVED	L > 63	±0.5
					UNSPECIFIED TOLERANCES
www.alpsr.com www.gdxidz.com www.xbswitch.com					



DSND		SCALE: N/A	MODEL TYPE:
DWN		VIEW:	TACT SWITCH
CHKD		UNIT: mm/in	PART NO.:
APPD		SIZE: A4	TS-1185-X-X-X-B
			DWG NO.:
			WEIGHT
			SHEET
			REVISIC
			1/1
			A0

DONG GUAN XI BANG ELECTRONIC CO., LTD